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### Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









### SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

### LC74763 LC74763M

### CMOSIC On-Screen Display LSI

### **Overview**

The LC74763 and LC74763M are on-screen display CMOS LSIs that superimpose text and low-level graphics onto a TV screen (video signal) under the control of a microcontroller. The display characters have a 12 by 18 dots structure, and 128 characters are provided.

### **Features**

- Display structure: 12 lines by 24 characters (up to 288 characters)
- Maximum character display: Up to 288 characters
- Character configuration: 12 (W) by 18 (H) dots structure
- Number of characters: 128 characters (128 plus space 2 fonts)
- Character sizes: Three sizes (normal, double, and triple sizes)
- Display starting positions: 64 horizontal and 64 vertical locations
- Reverse video function: Characters can be inverted on a per character basis.
- Flashing types: Two types with periods of 0.5 and 1.0 second on a per character basis (duty fixed at 50%)
- Background color: One of eight colors (when internal synchronization used)
- External control input: Serial data input in 8-bit units
- · Built-in horizontal/vertical sync separation circuit, AFC circuit, and synchronization detector
- Video output: Composite video signal output in NTSC, PAL, PAL-M, PAL-N, PAL60, NTSC4.43, or SECAM format

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### **Specifications**

### Absolute Maximum Ratings at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V <sub>DD</sub> max	V <sub>DD1</sub> , V <sub>DD2</sub> pins	V <sub>SS</sub> – 0.3 to V <sub>SS</sub> + 7.0	V
Maximum input voltage	V <sub>IN</sub> max	All input pins	$V_{SS} - 0.3 \text{ to } V_{DD} + 0.3$	V
Maximum output voltage	V <sub>OUT</sub> max	HSYNC <sub>OUT</sub> , VSYNC <sub>OUT</sub> , SYNC <sub>DET</sub> pins	$V_{SS} - 0.3$ to $V_{DD} + 0.3$	V
Allowable power dissipation	Pd max		300	mW
Operating temperature	Topr		-30 to +70	°C
Storage temperature	Tstg		-40 to +125	°C

### Allowable Operating Ranges at $Ta = -30 \text{ to } +70^{\circ}\text{C}$

Dawanatan	0	0			Unit		
Parameter	Symbol	Conditions	Conditions		typ	max	Offit
Supply voltage	V <sub>DD1</sub>	V <sub>DD1</sub> pin		4.5	5.0	5.5	V
Supply voltage	V <sub>DD2</sub>	V <sub>DD2</sub> pin		4.5	5.0	1.27 V <sub>DD1</sub>	V
	V <sub>IH1</sub>	RST, CS, SIN, SCLK pins		0.8 V <sub>DD1</sub>		V <sub>DD1</sub> + 0.3	V
Input high level voltage	V <sub>IH2</sub>	SECAM, 525/625, NTSC/PAL, 3.58/4.43 pins		0.7 V <sub>DD1</sub>		V <sub>DD1</sub> + 0.3	V
	V <sub>IL1</sub>	RST, CS, SIN, SCLK	V <sub>SS</sub> - 0.3		0.2 V <sub>DD1</sub>	V	
Input low level voltage	V <sub>IL2</sub>	SECAM, 525/625, NTSC/PAL, 3.58/4.43 pins	V <sub>SS</sub> - 0.3		0.3 V <sub>DD1</sub>	V	
Input voltage	V <sub>IN</sub>	FC, AMP <sub>IN</sub> pins		V <sub>SS</sub> - 0.3		V <sub>DD1</sub> + 0.3	V
	V <sub>IN1</sub>	CVIN pins			2 V <sub>PP</sub>		V
Composite video signal input voltage	V <sub>IN2</sub>	CV <sub>CR</sub> pins			2 V <sub>PP</sub>		V
	V <sub>IN3</sub>	SYNC <sub>IN</sub> pins			2 V <sub>PP</sub>	2.5 V <sub>PP</sub>	V
			NTSC		14.318		MHz
Ossillator fraguency	Face	Xtal <sub>IN1</sub> , Xtal <sub>OUT1</sub> , Xtal <sub>IN2</sub> ,	PAL		17.734		MHz
Oscillator frequency	F <sub>OSC1</sub>	Xtal <sub>OUT2</sub> pins; 4fsc	PAL-M		14.302		MHz
			PAL-N		14.328		MHz

### Electrical Characteristics at Ta = -30 to +70 °C, with $V_{DD1} = V_{DD2} = 5$ V unless otherwise specified

Davameter	Cumbal	Conditions	Ratings				
Parameter	Symbol	Conditions	min	typ	max	Unit	
Output off leakage current	I <sub>leak1</sub>	CV <sub>OUT</sub> pin			10	μΑ	
Input off leakage current	I <sub>leak2</sub>	CV <sub>IN</sub> , CV <sub>CR</sub> pins			10	μΑ	
Output high level voltage	V <sub>OH</sub>	$\begin{array}{l} \mbox{HSYNC}_{OUT}, \mbox{VSYNC}_{OUT}, \\ \mbox{SYNC}_{DET}, \mbox{SECAM}, \mbox{525/625}, \\ \mbox{NTSC/PAL}, \mbox{3.58/4.43}, \mbox{AMP}_{OUT}, \\ \mbox{PD}_{OUT} \mbox{pins; V}_{DD1} = 4.5 \mbox{ V, I}_{OH} = -1.0 \mbox{ mA} \end{array}$	3.5			V	
Output low level voltage	V <sub>OL</sub>	$\begin{array}{l} \mbox{HSYNC}_{OUT}, \mbox{VSYNC}_{OUT}, \\ \mbox{SYNC}_{DET}, \mbox{SECAM}, 525/625, \\ \mbox{NTSC/PAL}, 3.58/4.43, \mbox{AMP}_{OUT}, \\ \mbox{PD}_{OUT} \mbox{pins; V}_{DD1} = 4.5 \mbox{ V, I}_{OL} = 1.0 \mbox{ mA} \end{array}$			1.0	V	
Input ourrent	I <sub>IH</sub>	$\frac{\overline{RST}, \overline{CS}, SIN, SCLK, SECAM, \overline{525}/625,}{\overline{NTSC}/PAL, \overline{3.58}/4.43 \text{ pins; V}_{IN} = V_{DD1}}$			1	μА	
Input current	I <sub>IL</sub>	$\frac{\text{SECAM}}{3.58/4.43 \text{ pin; V}_{\text{IN}}} = \text{V}_{\text{SS1}}$	-1			μΑ	
Oscillator frequency	F <sub>OSC3</sub>	$VCO_{IN}$ , $VCO_{OUT}$ pins; $FC = 1/2 V_{DD1}$		14.12		MHz	
Operating current dissipation	I <sub>DD1</sub>	V <sub>DD1</sub> pin; All outputs open, Xtal: 4fsc			15	mA	
Operating durient dissipation	I <sub>DD2</sub>	$V_{DD2}$ pin; $V_{DD2} = 5.0 \text{ V}$			20	mA	

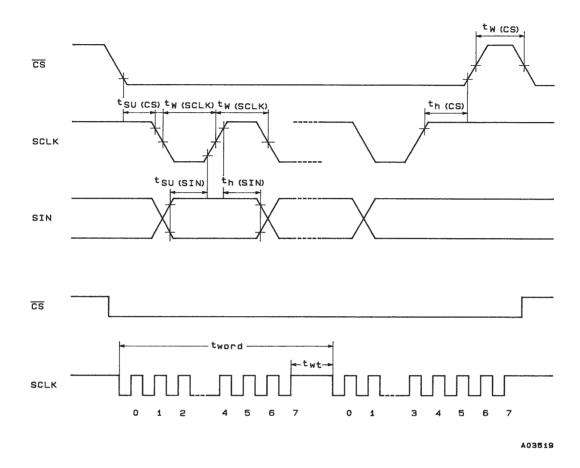
### Timing Characteristics at Ta = –30 to +70 $^{\circ}C,\,V_{DD}$ = 5 $\pm0.5~V$

Parameter	Cumbal	Symbol Conditions —		Ratings			
Parameter	Symbol			typ	max	Unit	
Minimum input pulse width	t <sub>W(SCLK)</sub>	SCLK pin	200			ns	
William Input pulse Width	t <sub>W(CS)</sub>	CS pin (during periods when CS is high)	1			μs	
Data setup time	t <sub>SU(CS)</sub>	CS pin	200			ns	
Data Scrap time	t <sub>SU(SIN)</sub>	SIN pin	200			ns	
Data hold time	t <sub>h(CS)</sub>	CS pin	2			μs	
Data Hold time	t <sub>h(SIN)</sub>	SIN pin	200			ns	
One word write time	t <sub>word</sub>	Write time for 8 bits of data	4.2			μs	
She word with time	t <sub>wt</sub>	RAM data write time	1			μs	

### **Pin Functions**

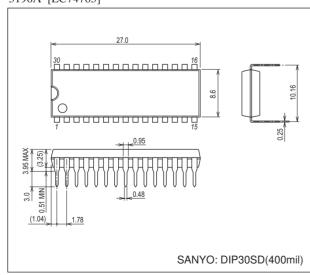
Pin No.	Symbol	Function	Description
1	V <sub>SS</sub>	Ground	Ground connection
2	Xtal <sub>IN1</sub>	0	Connection for the crystal and capacitor used to form the crystal oscillator that generates
3	Xtal <sub>OUT1</sub>	Crystal oscillator connection	the internal synchronization signal. The oscillator can be selected with a command switch.
4	HSYNC <sub>OUT</sub>	Horizontal synchronization output	Outputs the horizontal synchronization signal (AFC). The output polarity can be selected (metal option). Also functions as general output port (command switch).
5	Xtal <sub>IN2</sub>	Crystal oscillator connection	Connection for the crystal and capacitor used to form the crystal oscillator that generates
6	Xtal <sub>OUT2</sub>	Orystal Oscillator Conflection	the internal synchronization signal.
7	VSYNC <sub>OUT</sub>	Vertical synchronization output	Outputs the vertical synchronization signal. The output polarity can be selected (metal option). Also functions as general output port (command switch).
8	CS	Enable input	Enables/disables serial data input. Serial data is enabled when this pin is low (hysteresis input). Pull-up resistor built in (metal option).
9	SIN	Data input	Serial data input (hysteresis input). Pull-up resistor built in (metal option).
10	SCLK	Clock input	Clock input for serial data input (hysteresis input). Pull-up resistor built in (metal option).
11	SECAM	SECAM mode switch input/ output (command switch)	During input, switches between SECAM and other modes.  During output, functions as general output port or internal V output (command switch).  Low = other modes, high = SECAM mode
12	525/625	525/625 switch input/output (command switch)	During input, switches between 525 scan lines and 625 scan lines.  During output, functions as general output port or character data output (command switch).  Low = 525 lines, high = 625 lines
13	NTSC/PAL	NTSC/PAL switch input/output (command switch)	Switches the color mode between NTSC and PAL.  During output, functions as general output port or frame data output (command switch).  Low = NTSC, high = PAL
14	3.58/4.43	3.58/4.43 switch input/output (command switch)	Switch FSC between 3.58 MHz and 4.43 MHz.  During output, functions as general output port or halftone output (command switch).  Low = 3.58, high = 4.43
15	RST	Reset input	System reset input pin, low is active (hysteresis input). Pull-up resistor built in (metal option).
16	CV <sub>OUT</sub>	Video signal output	Composite video output
17	V <sub>DD2</sub>	Power supply connection	Power supply connection for composite video signal level generation
18	CVIN	Video signal input	Composite video input
19	CV <sub>CR</sub>	Video signal input	SECAM chroma signal input
20	SYNC <sub>IN</sub>	Sync separator circuit input	Built-in sync separator circuit video signal input
21	SEP <sub>C</sub>	Sync separator circuit	Built-in sync separator circuit
22	V <sub>SS</sub>	Ground	Ground connection
23	PD <sub>OUT</sub>	Control voltage output	AFC control voltage output
24	AMP <sub>IN</sub>	AFC filter connection	Filter connection
25	AMP <sub>OUT</sub>	2	
26	FC	Control voltage input	AFC control voltage input
27	VCO <sub>IN</sub>	LC oscillator connection	VCO LC oscillator circuit coil and capacitor connection
28	VCO <sub>OUT</sub>		
29	SYNC <sub>DET</sub>	External synchronization signal detection output	Outputs the exclusive NOR of the horizontal synchronization signal (AFC) and CSYNC (sync separator). The output polarity can be selected (metal option). Also functions as general output port (command switch).
30	V <sub>DD1</sub>	Power supply connection	Power supply connection (+5 V: digital system power supply)

### **Serial Data Input Timing**



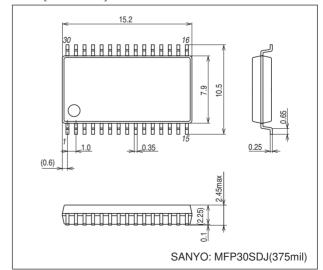
### **Package Dimensions**

unit : mm (typ) 3196A [LC74763]

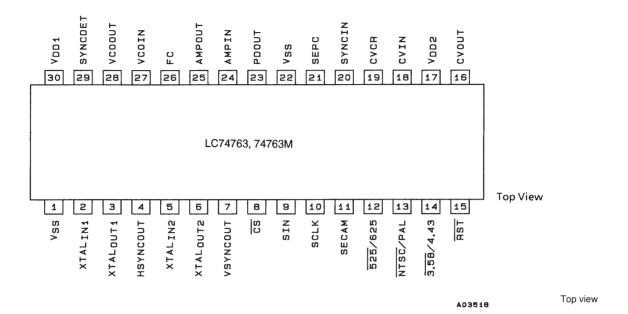


### **Package Dimensions**

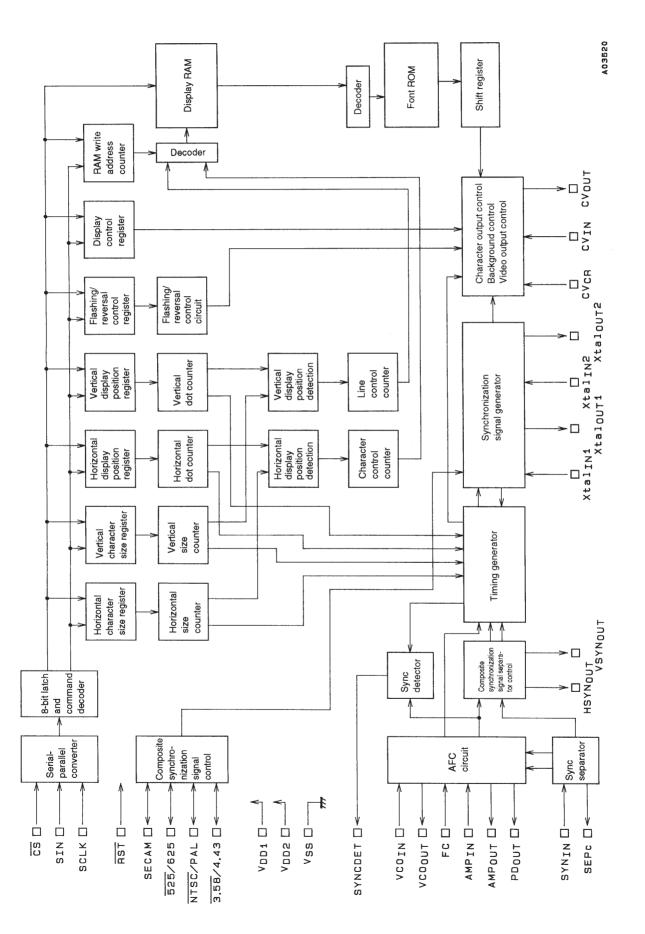
unit : mm (typ) 3312 [LC74763M]



### **Pin Assignment**



### **System Block Diagram**



### **Display Control Commands**

Display control commands are input in an 8-bit serial format. Commands consist of a command identification code in the first byte and data in the second and following bytes. The following commands are supported.

① COMMANDO: Display memory (VRAM) write address setting command

② COMMAND1: Display character data write command

3 COMMAND2: Vertical display start position and character size (lines 1 and 2) setting command
 4 COMMAND3: Horizontal display start position and character size (lines 9 and 11) setting command

© COMMAND4: Display control setting command 1
 © COMMAND5: Display control setting command 2
 © COMMAND6: Display control setting command 3
 ® COMMAND7: Display control setting command 4

### **Display Control Command Table**

				First	byte							Secor	nd byte			
Command	Comm	and ide	ntificatio	n code		Da	ata					Da	ata			
	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0
COMMAND0 Write address	1	0	0	0	V3	V2	V1	V0	0	0	0	H4	НЗ	H2	H1	H0
COMMAND1 Character write	1	0	0	1	0	0	at2	at1	с7	c6	c5	c4	сЗ	c2	c1	c0
COMMAND2 Vertical display start position	1	0	1	0	SZ 21	SZ 20	SZ 11	SZ 10	0	0	VP 5	VP 4	VP 3	VP 2	VP 1	VP 0
COMMAND3 Horizontal display start position	1	0	1	1	SZ B1	SZ B0	SZ 91	SZ 90	0	0	HP 5	HP 4	HP 3	HP 2	HP 1	HP 0
COMMAND4 Display control 1	1	1	0	0	RST	RAM	OSC	RND	0	I/N	BLK 1	BLK 0	BK 1	ATS	0	DSP
COMMAND5 Display control 2	1	1	0	1	PH 2	PH 1	PH 0	I/E	0	TST	CHAL	BKL	RSL 1	RSL 0	CVM	XTS
COMMAND6 Display control 3	1	1	1	0	MOD 3	MOD 2	MOD 1	MOD 0	0	HFI	M30S	SMS	IOS	BCL 1	BCL 0	СВ
COMMAND70 Display control 4	1	1	1	1	0	0	0	LINS	0	vcos 1	LIN 5	LIN 4	LIN 3	LIN 2	LIN 1	LIN 0
COMMAND71 Display control 5	1	1	1	1	0	1	0	LINS	0	EG 2	PS 2	PS 1	VMN	SVIS	VNS	VSS
COMMAND72 Display control 6	1	1	1	1	1	0	0	LINS	0	0	0	0	MOD 3	MOD 2	MOD 1	MOD 0
COMMAND73 Display control 7	1	1	1	1	1	1	0	LINS	0	0	0	0	VCOS 2	SOUT	VOUT	HOUT

Once the command identification code in the first bite is written, it is stored internally until the first byte of the following command is written. However, when the display character data write command (COMMAND1) is written, the system becomes locked in display character data write mode, and the first byte cannot be overwritten.

When the  $\overline{\text{CS}}$  pin is set high the command state is set to COMMAND0, i.e., display memory write address setting mode.

### ① COMMAND0: Display Memory Write Address Setting Command

### First data byte

DA0 to DA7	Desister nome		Register content	Note	
DAU IO DA7	Register name	State	Function	Note	
7	_	1			
6	_	0	The command 0 identification code:		
5	_	0	sets the display memory write address.		
4	_	0			
3	V3	0			
3	VS	1			
2	V2	0			
2	VZ	1	Display memory line address (from 0 to B (hexadecimal))		
1	V1	0	Display memory line address (notified to b (nexadeclinal))		
'	v !	1			
0	VO	0			
	VU	1			

### Second byte

DA0 +- DA7	Danistan asses		Register content	Nete
DA0 to DA7	DA0 to DA7 Register name		Function	Note
7	_	0	Second byte identification code	
6	_	0		
5	_	0		
4	H4	0		
7	114	1		
3	H3	0		
3	113	1		
2	H2	0	Display memory character address (from 0 to 17 (hexadecimal))	
2	112	1	Display memory character address (nom o to 17 (nexadecimal))	
1	H1	0		
'	'''	1		
0	H0	0		
	110	1		

Note: When the chip is reset by the  $\overline{\text{RST}}$  pin, the register states (bits) are all cleared to 0.

### ② COMMAND1: Display Character Data Write Setting Command

DA0 +- DA7	Danistan sama		Register content	Nete										
DA0 to DA7	Register name	State	Function	Note										
7	_	1												
6	_	0	The command 1 identification code:	When this command is entered, the chip locks in display character write										
5	_	0	mode until the CS pin is set high.											
4	_	1												
3	_	0												
2	_	0												
1	o+0	o+0	o+0	o+0	a+0	040	0+0	2+2	0+0	at2	at2	0	Turns character attribute 2 off.	Specifies highlight or flashing.
	aız	1	Turns character attribute 2 on.	opeomes nigningition hashing.										
0	at1	011	011	ot1	0	Turns character attribute 1 off.	Specifies reverse video.							
		1	Turns character attribute 1 on.	opeomes reverse video.										

### Second byte

			Register content	
DA0 to DA7	Register name	State	Function	Note
7	c7	0		
,	C7	1		
6	c6	0		
0	CO	1		
5	c5	0		
3	63	1		
4	c4	0		
		1	Character code (from 00 to 7F, FE, FF)	
3	сЗ	0	Onaracter code (nom oo to 71 , 1 L, 11 )	
3	65	1		
2	c2	0		
	02	1		
1	c1	0		
	01	1		
0	c0	0		
	CO	1		

Note: When the chip is reset by the  $\overline{RST}$  pin, the register states (bits) are all cleared to 0.

### ③ COMMAND2: Vertical Display Position Setting Command

### First byte

DA0+- DA7	Danista and a			Register content	Nete	
DA0 to DA7	Register name	State		Note		
7	_	1				
6	_	0	The command 2 is	dentification code:		
5	_	1	sets the vertical d	isplay position.		
4	_	0				
3	SZ21	0	SZ20	_		7
3	3221	1	SZ21	0	1	Character size for the second line
0	0700	0	0	Normal size	Double size	Character size for the second line
2	SZ20	1	1	Triple size	Normal size	<u> </u>
4	0711	0	SZ10			7
'	SZ11	1	SZ11	0	1	
	0740	0	0	Normal size	Double size	Character size for the first line
0	SZ10	1	1	Triple size	Normal size	]

### Second byte

DA0 to DA7	Desister name		Register content	Note	
DA0 to DA7	Register name	State	Function	Note	
7	_	0	Second byte identification code		
6	_	0			
5	VP5	0	The vertical display start position is given by		
5	(MSB)	1	$VS = H \times (\begin{array}{cc} 5 \\ \Sigma \end{array} 2^{n}VPn)$		
4	VP4	0	$VS = H \times (\sum_{n=0}^{\infty} 2^{n}VPn)$		
4	VP4	1	where H is the horizontal synchronization pulse period.		
3	VP3	0	HSYNC	The six bits VP0 to VP5 specify the	
3	VF3	1	, 7	vertical display start position.	
2	VP2	0		The weight of the lsb is 1 × H.	
2	VF2	1	$ \hspace{.05cm} \hspace{.05cm} \hspace{.05cm} \hspace{.05cm} \hspace{.05cm} $		
1	VP1	0			
'	VFI	1	Character		
0	VP0	0	HS display area		
	(LSB)	1			

Note: When the chip is reset by the  $\overline{\text{RST}}$  pin, the register states (bits) are all cleared to 0.

### **4** COMMAND3: Horizontal Display Position Setting Command

### First byte

DA0 +- DA7	Danista a sama			Register content	Ness	
DA0 to DA7	Register name	State		Function		Note
7	_	1				
6	_	0	The command 3 i	dentification code:		
5	_	1		al display position.		
4	_	1				
3	SZB1	0	SZB0			
3	3261	1	SZB1	0	1	The above stay size for the clayenth line
_	0700	0	0	Normal size	Double size	The character size for the eleventh line.
2	SZB0	1	1	Triple size	Normal size	
_	0704	0	SZ90			1
'	SZ91	1	SZ91	0	1	
		0	0	Normal size	Double size	The character size for the ninth line.
0	SZ90	1	1	Triple size	Normal size	

### Second byte

			Register content	
DA0 to DA7	Register name	State	Function	Note
7	_	0	Second byte identification code	
6	_	0		
_	HP5	0		
5	(MSB)	1		
		0		
4	HP4	1	The horizontal display start position is given by	
	LIDO	0	, , , , , , , , , , , , , , , , , , , ,	The six bits HP0 to HP5 specify the
3	HP3	1	$HS = Tc \times (\sum_{n=0}^{5} 2^{n}HPn)$	vertical display start position.
		0	11 – 0	The weight of the lsb is 1 x Tc.
2	HP2	1	where Tc is the period of the OSCIN and OSCOUT oscillator in	
_	1 HP1 0	0	operating mode.	
1		1		
	HP0	0		
0	(LSB)	1		

Note: When the chip is reset by the  $\overline{\mbox{RST}}$  pin, the register states (bits) are all cleared to 0.

### ⑤ COMMAND4: Display Control Setting Command 1

DAG 1 DA7	DA0 to DA7 Register name		Register content	Note	
DAU to DA7			Function	Note	
7	_	1			
6	_	1	The command 4 identification code:		
5	_	0	sets display control parameters.		
4	_	0			
0	DOT	0		This reset occurs when the CS pin goes low, and the reset state cleared when	
3	RST <sub>SYS</sub>	1	Resets all registers. (Clears all registers to 0.)	the CS pin goes high.	
0	DAM	0		The RAM erase function requires at least 500 µs.	
2	RAM <sub>ERS</sub>	1	Erases display RAM. (Sets display RAM to FF (hexadecimal).)	It is executed on DSPOFF.	
1	OSC <sub>STP</sub>	0	Continues crystal oscillator operation.	Only valid with character display off if	
	, coogip	1	Stops the crystal oscillator.	external synchronization is used.	
0	RND <sub>SFI</sub>	0 Turns off rounding.		Only valid for double and triple size	
U RND <sub>SEL</sub>		1	Turns on rounding.	characters.	

### Second byte

DAG 1 DA7	B			Register content	No	
DA0 to DA7	Register name	State		Function		Note
7	_	0	Second byte ide	entification code		
6	INT/NON	0	Interlaced			Switches between interlaced and
0	IN I/NON	1	Non-interlaced			non-interlaced display.
5	BLK1	0	BLK0	_		
5	DLNI	1	BLK1	0	1	Changes the blanking size
4	DLIKO	0	0	Blanking off	Character size blanking	Changes the blanking size.
4	BLK0	1	1	Frame size blanking	Total area blanking	
3	BK1	0	Flashing period	about 0.5 s		Cata the fleeking paying
3	DNI	1	Flashing period	about 1 s		Sets the flashing period.
0	ATO	0	Highlight function	on		Colonto at 0
2	2 ATS 1 Flashing function					Selects at2.
1	_	0				
0	DEBON	0	Character displa	ay off		Turns sharester output on and off
U	0 DSPON		Character displa	ay on	Turns character output on and off.	

Note: When the chip is reset by the  $\overline{\text{RST}}$  pin, the register states (bits) are all cleared to 0.

### © COMMAND5: Display Control Setting Command 2

DA0 +- DA7	Danistan sana			Regist	er content			Note						
DA0 to DA7	Register name	State			Function			Note						
7	_	1												
6	_	1	The comma	and 5 identific	ation code:									
5	_	0	sets display	control para	meters.									
4	_	1												
3	PH2	0	PHASE 2	PHASE 1	PHASE 0	Backgrou (phase)	und color							
		1				NTSC	PAL							
			0	0	0	π/2	±π/2							
		0	0	0	1	In phase	In phase	Sets the phase of the background color						
2	PH1		0	1	0	3 π/2	∓π/2	for color burst.sz						
								1	1	0	1	1	π	±π
									1	0	0	3 π/4	±3 π/4	
		0	1	0	1	π/4	±π/4							
1	PH0 1	PH0	PH0	PH0		1	1	0	7 π/4	∓π/4				
		1	1	1	1	5 π/4	∓3 π/4							
0	INT/EXT	0	External sy	External synchronization mode			Switches between internal and external							
J		1	Internal syn	chronization	mode			synchronization.						

### Second byte

DA0+- DA7	Danistan sana			Regist	er content	Nete											
DA0 to DA7	Register name	State			Function		Note										
7	_	0	Second byt	e identification	on code												
6	TST	0	Normal ope	ration			Test mode should not be used. This bit										
0	151	1	Test mode				should always be zero.										
		0	Sets the ch	aracter inten	sity level to about 8	5 IRE (bright white).											
5	CHAL	1	Sets the characteristics touch of great		sity level to about 72	Switches the character intensity level.											
	DIA	0	Sets the bla		ity level to about 3 I												
4	BKL	1	Sets the bla		ity level to about 13	IRE (a dark grey	Switches the blanking intensity level.										
		0	RSL1	RSL0	Intensity level	Amplitude											
3	RSL1	1	0	0	About 15 IRE	About 60 IRE											
			0	1	About 30 IRE	About 60 IRE	Switches the background intensity level.										
2	RSL0 0	RSI 0	RSLO	RSI 0	RSI 0	BSI 0	BSI 0	BSI 0	RSI 0	RSLO	RSLO	0	1	0	About 45 IRE	About 60 IRE	
_		1	1	1	About 55 IRE	About 65 IRE											
4	CV	0	Normal CV	output													
ı	CV <sub>outmt</sub>	1	CV <sub>out</sub> pede	stal level out	put	1											
0	VTAL .	0	Selects XT/	AL1		Cuitabas the assillator sireuit											
0	XTAL <sub>sel</sub>	1	Selects XT/	AL2			Switches the oscillator circuit										

Note: When the chip is reset by the  $\overline{\text{RST}}$  pin, the register states (bits) are all cleared to 0.

### © COMMAND6: Display Control Setting Command 3

			Register content			
DA0 to DA7 Register name		State	Function	Note		
7	_	1				
6	_	1	The command 6 identification code:			
5	_	1	sets display control parameters.			
4	_	0				
0			0		Sets Fsc to 3.58 MHz.	The logical or of this bit and the Fsc
3	MOD3	1	Sets Fsc to 4.43 MHz.	switching input pin (pin 14) is used.		
		0	Sets the color mode to NTSC.	The logical or of this bit and the color		
2	MOD2	1	Sets the color mode to PAL.	mode switching input pin (pin 13) is used.		
				0	Sets the number of scan lines to 525 lines.	The logical or of this bit and the scan
1 MOD1	1	Sets the number of scan lines to 625 lines.	line count switching input pin (pin 12) is used.			
0	MODO	0	Sets the mode to a mode other than SECAM.	The logical or of this bit and the mode		
0 MOD0		1	Sets the mode to SECAM mode.	switching input pin (pin 11) is used.		

### Second byte

DA0 +- DA7	Danista a sassa			Regist	er content	Ness										
DA0 to DA7	Register name	State			Function	Note										
7	_	0	Second byt	e identification	on code											
6	HALF	0	Normal mo	de												
0	INT	1	Half interna	ıl synchronou	is mode											
5	P14OUT	0	Halftone ou	itput		Colonto D14 (2 59/4 42) autout										
5	SEL	1	High output	in internal s	ynchronous mode	Selects P14 (3.58/4.43) output.										
4	SECAM	0	In SECAM	mode, only tl	ne character frame area is on.	Calasta the CVCD "an" navied										
4	SEL	1	In SECAM	mode, the er	ntire character display area is on.	Selects the CVCR "on" period.										
3	IOS	0	Sets the mo	ode setting p	in to be an input pin.	Switches the input/output direction of										
3	103	1	Sets the mo	ode setting p	in to be an output pin.	the mode setting pins.										
		0	BCOL1	BCOL0	Background color											
2	BCOL1	1	0	0	Background color displayed	Determines whether a background color										
		0	0	1	No background color (about 13 IRE)	is displayed. (Only valid in internal										
1	BCOL0	BCOLO	BCOL0	BCOL0	BCOL 0	BCOL 0	BCOL0	BCOL0	BCOL0	BCOL0	1 BCOL0	0	1	0	No background color (about 23 IRE)	synchronization mode.)
	20020	1	1	1	CV <sub>outmt2</sub> (CSYNC)											
0	CBOFF	0	Outputs a c	olor burst sig	gnal.	Only valid when either BCOL0 is 1 or										
	CBOIT	1	Stops the o	utput of colo	r burst signals.	BCOL1 is 1.										

Note: When the chip is reset by the  $\overline{\mathsf{RST}}$  pin, the register states (bits) are all cleared to 0.

### ® COMMAND70: Display Control Setting Command 4

### First byte

DAG 1 DA7	DAO to DA7   Degister name		Register content	N
DA0 to DA7	Register name	State	Function	Note
7	_	1		
6	_	1	The command 7 identification code:	
5	_	1	sets display control parameters.	
4	_	1		
3	_	0	Companying a command O identification and	
2	_	0	Expansion command 0 identification code	
1	_	0		
0	0 LINS	0	Selects the lower 6 bits (bits 0 to 5)	Selects the upper or lower six bits when
U LINS		1	Selects the upper 6 bits (bits 6 to B)	halftone output line mode is specified.

### Second byte

DAG 1 DA7	B		Register content	N						
DA0 to DA7	Register name	State	Function	Note						
7	_	0	Second byte identification code							
6	VCO	0	VCO frequency is 14.12 MHz	Calasta VCO assillation fraguency						
б	SELECT1	1	VCO frequency is 7.07 MHz	Selects VCO oscillation frequency.						
5	LIN5	0	Turns off (low) sixth line halftone output.	Used for the line 12 setting when LINS						
5	LINO	1	Turns on (high) sixth line halftone output.	is high.						
4	1.1514	1.1514	1.1514	1.1514	1.1514	LIN4	1.1514	0	Turns off (low) fifth line halftone output.	Used for the line 11 setting when LINS
4	LIN4	1	Turns on (high) fifth line halftone output.	is high.						
3	LIN3	CIALI	0	Turns off (low) fourth line halftone output.	Used for the line 10 setting when LINS					
3	LINS	1	Turns on (high) fourth line halftone output.	is high.						
2	LIN2	0	Turns off (low) third line halftone output.	Used for the line 9 setting when LINS is						
2	LINZ	1	Turns on (high) third line halftone output.	high.						
4	LIN1	0	Turns off (low) second line halftone output.	Used for the line 8 setting when LINS is						
I	1 LINI 1		Turns on (high) second line halftone output.	high.						
0	LINO	0	Turns off (low) first line halftone output.	Used for the line 7 setting when LINS is						
0 LIN0	1	Turns on (high) first line halftone output.	high.							

Note: When the chip is reset by the  $\overline{\text{RST}}$  pin, the register states (bits) are all cleared to 0.

### © COMMAND71: Display Control Setting Command 5

### First byte

DA0 to DA7	Desister nome		Register content	Note
DA0 to DA7	Register name	State	Function	Note
7	_	1		
6	_	1	The command 7 identification code: sets display	
5	_	1	control parameters	
4	_	1		
3	_	0	Expansion command 1 identification code	
2	_	1	Expansion command indentification code	
1	_	0		
0	0 LINS	0	Selects lower 6 bits (0 to 5).	Selects lower or upper 6 bits for half-
LINS		1	Selects upper 6 bits (6 to B).	tone output line setting.

### Second byte

DAG   DA7	D		Register content	N				
DA0 to DA7	DA0 to DA7 Register name Sta		Function	Note				
7	_	0	Second byte identification bit					
6	EGMODE	0	Normal display					
O	2SELECT	1	Applies frame to inverted characters also.	1				
5	PORTSET	0	Sets port output data					
J	SELECT2	1	Sets port (output switching)	1				
4	PORTSET		Sets port output data					
4	SELECT1	1	Sets port (output switching)	7				
3	o VMN	VMN 0	0	Normal V signal				
3	SEL	1	VMASK signal	1				
2	VINPsel	0	Normal I/O					
2	VIINESEI	1	V is input from P11.	1				
1	\/NIDI	\/NIDI	VNDeel	VNPsel	\/NDeel	0	V rise detection	Selects V detection polarity.
ı	i vinesei		V fall detection	Selects v detection polarity.				
0	VSEPsel 0 VSEF		VSEP is about 9.3 μs.	Soloots V congration time				
U	VOEPSEI	1	VSEP is about 18.6 μs.	Selects V separation time.				

Note: When the chip is reset by the  $\overline{\text{RST}}$  pin, the register states (bits) are all cleared to 0.

### © COMMAND72: Display Control Setting Command 6

DA0 +- DA7	Danista a sama	Register content		N	
DA0 to DA7	Register name	State	Function	Note	
7	_	1			
6	_	1	The command 7 identification code: sets display		
5	_	1	control parameters		
4	_	1			
3	_	1	Expansion command 2 identification code		
2	_	0	Expansion command 2 identification code		
1	_	0			
0	LINS	0	0	Selects lower 6 bits (0 to 5).	Selects lower or upper 6 bits for half-
0		1	Selects upper 6 bits (6 to B).	tone output line setting.	

### Second byte

DA0 to DA7	Register name	Register content			
		State	Function	Note	
7	_	0	Second byte identification bit		
6	_	0			
5	_	0			
4	_	0			
3	MOD3 SEL	0	Normal MOD3 (P14) output (PS1 = 1)	Specifies port output data	
3		1	Specifies MOD3 general port output	when PS1 = 0.	
2	MOD2 SEL	0	Normal MOD2 (P13) output (PS1 = 1)	Specifies port output data	
2		SEL	1	Specifies MOD2 general port output	when PS1 = 0.
4	MOD1 SEL	MOD1	0	Normal MOD1 (P12) output (PS1 =1)	Specifies port output data
'		1	Specifies MOD1 general port output	when PS1 = 0.	
0	MOD0 SEL	0	Normal MOD0 (P11) output (PS1 = 1)	Specifies port output data	
0		1	Specifies MOD0 general port output	when PS1 = 0.	

Note: When the chip is reset by the RST pin, the register states (bits) are all cleared to 0.

### ① COMMAND73: Display Control Setting Command 7

### First byte

D40. D47	Register name	Register content			
DA0 to DA7		State		Function	Note
7	_	1			
6	_	1	The command 7 identification code: sets display		
5	_	1	control parameters		
4	_	1			
3	_	1	Expansion command 3 identification code		
2	_	1	Expansion command 3 identification code		
1	_	0			
0	LINS		0	Selects lower 6 bits (0 to 5).	Selects lower or upper 6 bits for half
		1	Selects upper 6 bits (6 to B).	tone output line setting.	

### Second byte

DAG 1 DA7	Register name	Register content			
DA0 to DA7		State	Function	Note	
7	_	0	Second byte identification bit		
6	_	0			
5	_	0			
4	_	0			
3	VCP SELECT2	0	No feedback resistance	Specifies VCO oscillator feedback	
3		1	Feedback resistance	resistance connection	
2	SDETOUT SEL	0	Normal SOUT (P29) output (PS2 = 1)	Specifies port output data	
2		1	Specifies SOUT general port output	when PS2 = 0.	
4	VOUT SEL	VOUT	0	Normal VOUT (P7) output (PS2 =1)	Specifies port output data
1		1	Specifies VOUT general port output	when PS2 = 0.	
0	HOUT SEL	0	Normal HOUT (P4) output (PS2 = 1)	Specifies port output data	
0		1	Specifies HOUT general port output	when PS2 = 0.	

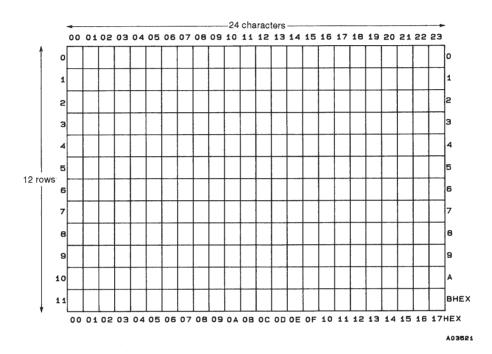
Note: When the chip is reset by the  $\overline{\text{RST}}$  pin, the register states (bits) are all cleared to 0.

### **Display Configuration**

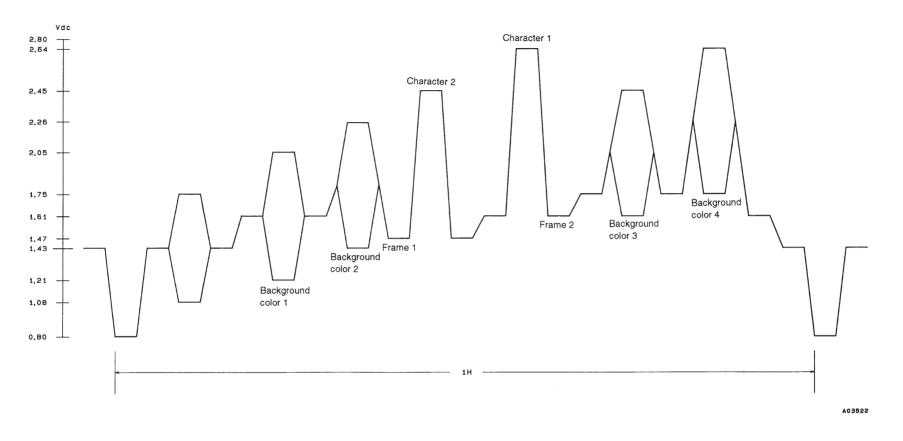
The display consists of 12 rows of 24 characters each. Up to 288 characters can be displayed unless enlarged characters are displayed. Display memory addresses are expressed as a row address in the range 0 to B (hexadecimal) and a column address in the range 0 to 17 (hexadecimal).

### **Display Configuration and Display Memory Addresses**

24 characters by 12 rows



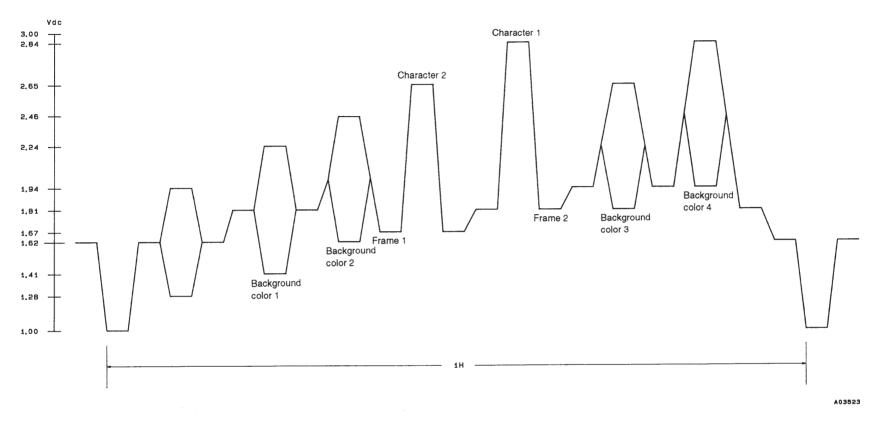
# Composite Video Signal Output Levels (internally generated levels) Metal Option



Output level	Output voltage (VDC)		
Character level 1	2.638		
Character level 2	2.449		
Background high level 2	2.262		
Background high level 1	2.047		
Burst high level	1.747		
Frame level 2	1.610		

	1	
Output level	Output voltage (VDC)	
Frame level 1	1.465	
Pedestal level	1.429	
Background low level 1	1.212	
Burst low level	1.080	
Sync level	0.800	

# Composite Video Signal Output Levels (internally generated levels) Metal Option

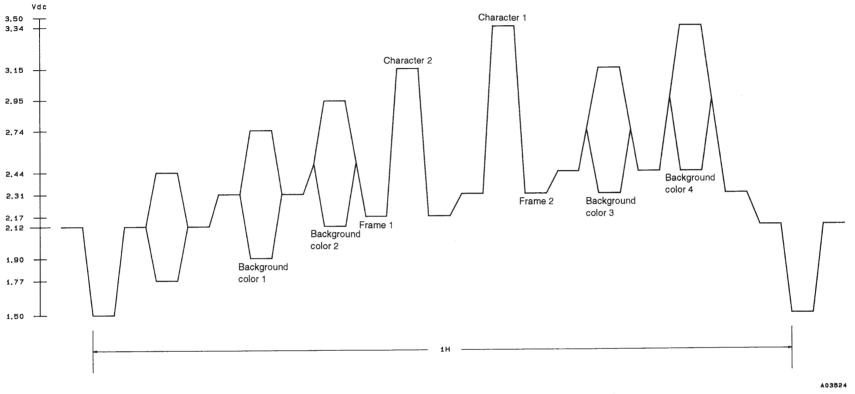


Output level	Output voltage (VDC)	
Character level 1	2.841	
Character level 2	2.652	
Background high level 2	2.456	
Background high level 1	2.242	
Burst high level	1.943	
Frame level 2	1.811	

Output level	Output voltage (VDC)	
Frame level 1	1.665	
Pedestal level	1.624	
Background low level 1	1.407	
Burst low level	1.275	
Sync level	1.000	

Composite Video Signal Output Levels (internally generated levels) Metal Option

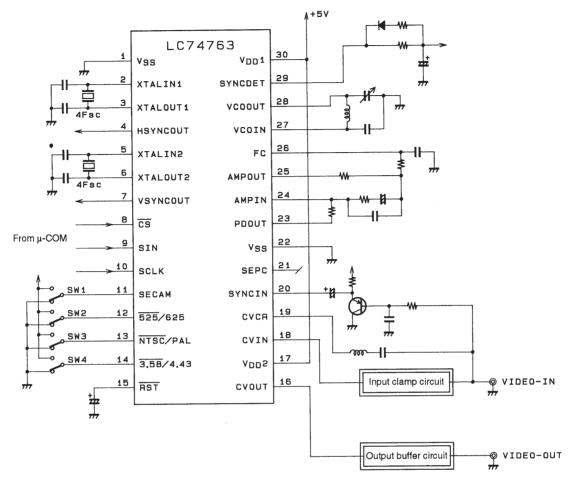
### A03524



Output level	Output voltage (VDC)		
Character level 1	3.342		
Character level 2	3.153		
Background high level 2	2.950		
Background high level 1	2.735		
Burst high level	2.436		
Frame level 2	2.312		

Output level	Output voltage (VDC)	
Frame level 1	2.166	
Pedestal level	2.118	
Background low level 1	1.902	
Burst low level	1.770	
Sync level	1.500	

### **Application Circuit Diagram**



A03525

Signal format	4 Fsc (MHz)
NTSC	3.579545 × 4
PAL	4.433618 × 4
SECAM	4.433618 × 4
PAL-M	3.575611 × 4
PAL-N	3.582056 × 4
NTSC4.43	4.433618 × 4
PAL60	4.433618 × 4

Signal format	SW1	SW2	SW3	SW4
NTSC	0	0	0	0
PAL	0	1	1	1
SECAM	1	(1)	(1)	(1)
PAL-M	0	0	1	0
PAL-N	0	1	1	0
NTSC4.43	0	0	0	1
PAL60	0	0	1	1

Note: Fix SW1 to SW4 to 0 when setting a mode by command.

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